

Low Loss Current Limited Power Switch

General Description

The WP25141T5-B is current limited P-channel MOSFET power switch designed for high-side load switching applications. This switch operates with inputs ranging from 2.5V to 5.5V, making it ideal for both 3.3V and 5V systems. An integrated current-limiting circuit protects the input supply against large currents which may cause the supply to fall out of regulation. The WP25141T5-B will be also into protection state due to thermal overload which is caused by limited power dissipation and junction temperature. It can be used to control load that requires 1.4A. The quiescent supply current in active mode is only $28\mu A$. In shutdown mode, the supply current decreases to less than $1\mu A$. Fault flag (FLT) can indicate over current and fault conditions.

The WP25141T5-B is available in Pb-free packages and is specified over the -40°C to +85°C ambient temperature range.

Features

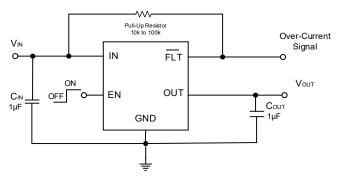
- Input Voltage Range: 2.5V to 5.5V
- 2A Accurate Current Limit
- Reverse Current Blocking
- Short-Circuit Response: 2µs

- Very Low Quiescent Current: 28µA (Typ)
- 1µA Max Shutdown Supply Current
- Fault Flag (FLT) output for over current and fault conditions
- Built-in Pull-up Resistor for EN Pin
- Automatic Output Discharge at Shutdown
- Under-Voltage Lockout
- Thermal Shutdown
- 2kV ESD Rating
- Package: SOT23-5
- Ambient Temperature Range: -40°C to +85°C

Applications

- Laptop/Desktop Computers and Netbooks
- 3G Wireless Cards
- Smart Phones and PDAs
- LCD TVs and Monitors
- Set-Top-Boxes
- MP3/MP4
- Printers
- Portable Game Players
- Portable Media Players and MIDs
- USB Keyboards
- USB Hard Disk Drives
- USB Memory Drives
- USB Hubs

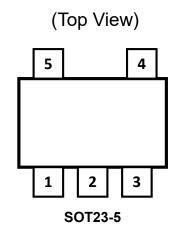
Typical Application



Note: Tantalum or Aluminum Electrolytic capacitors (CIN and COUT) may be required for USB applications



Pin Configuration



Pin Description

Pin Number	Pin Name	Pin Function
1	OUT	Power output.
2	GND	Ground pin.
3	FLT	Open drain fault flag.
4	EN	Enable input, High enable.
5	IN	Power supply input.

Absolute Maximum Ratings

Parameter	Rating	Unit
IN, EN, FLT Voltage	-0.3 to 6	V
OUT Voltage	-0.3 to V _{IN} + 0.3	V
OUT Current	Internal Limited	Α
Power Dissipation	400	mW
Package Thermal Resistance (θ_{JA})	250	°C/W
Operating Junction Temperature	-40 to 125	°C
Storage Temperature	-55 to 150	°C
Lead Temperature (Soldering, 10 sec)	300	°C

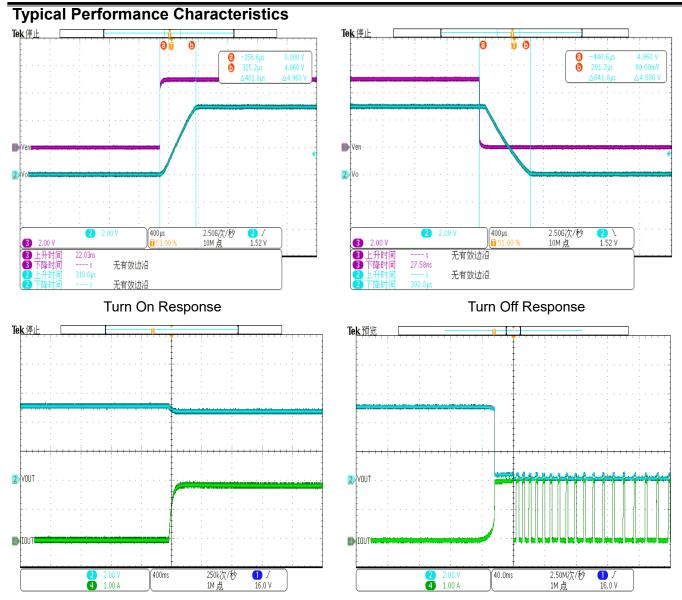


Electrical Characteristics

 $(V_{IN}=+5.0V, T_A=-40^{\circ}C \text{ to } 85^{\circ}C, \text{ typical values at TA}=25^{\circ}C, \text{ unless otherwise stated})$

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{IN}	Input Voltage Range		2.5		5.5	V
I _{SHDN}	Input Shutdown Quiescent Current	Disabled, OUT floating or shorted to ground		0.1	1	μА
IQ	Input Quiescent Current	Enabled, I _{OUT} =0A		25	60	μΑ
R _{DS(ON)}	Switch on-resistance	Vin=5V, lout=1A		80	120	mΩ
I _{LMT}	Current Limit	VIN=5V, VOUT=4.5V	1.6	2	2.4	Α
V _{IL}	EN Input Logic Low Voltage				0.5	V
V _{IH}	EN Input Logic High Voltage		1.5			V
I _{SINK}	EN Input leakage	V _{EN} =5V		0.01	1	μΑ
V_{UVLO}	Input UVLO		1.4	1.8	2.2	V
V_{UVLOHys}	UVLO Hysteresis			0.1		٧
I _{REV}	Reverse leakage current	V_{OUT} = 5V , V_{IN} =0V , V_{EN} =0V I_{REV} at V_{IN}		0.1	1	μΑ
T _{SHDN}	Thermal shutdown threshold	V _{IN} = 5V		150		°C
T _{HYS}	Thermal shutdown hysteresis	V _{IN} = 5V		20		°C
$R_{\overline{FLT}}$	FLT Low Resistance			80		Ω
T _{FLT_Delay}	FLT Delay Time			15		ms
R _{discharge}	Output discharge FET R _{DS(ON)}	Disabled, Vin = 5V, Vour=1V	50	120	300	Ω
T _{ON}	Output Turn-on Delay Time	VIN =5V, CL=1 μ F, RLOAD=100 Ω	0.2	0.5	1	ms
T _R	Output Turn-on Rise Time	VIN =5V, CL=1μF, RLOAD=100Ω	0.2	0.4	0.8	ms
T _{OFF}	Output Turn-off Delay Time	VIN =5V, CL=1μF, RLOAD=100Ω	0.2	0.5	0.8	ms
T _F	Output Turn-off Fall Time	VIN =5V, CL=1μF, RLOAD=100Ω	100	350	500	μs
ESD HBM	Human Body Model ESD Protection			2000		V

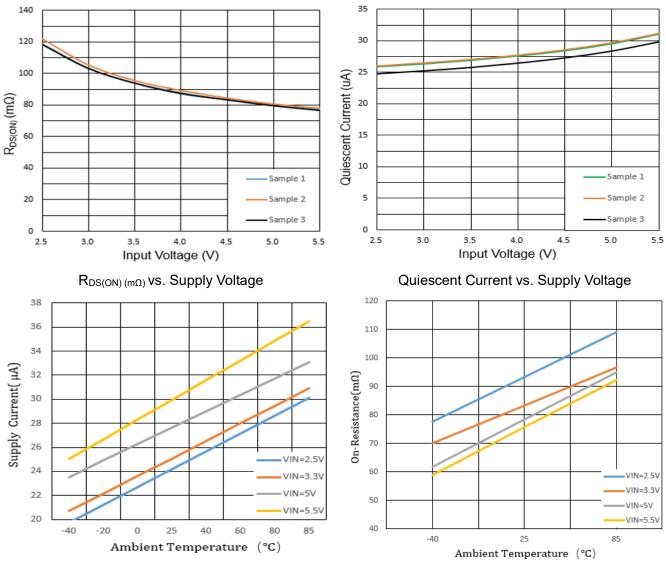




Overload Current-Limit

Short Current Response & Thermal Shutdown

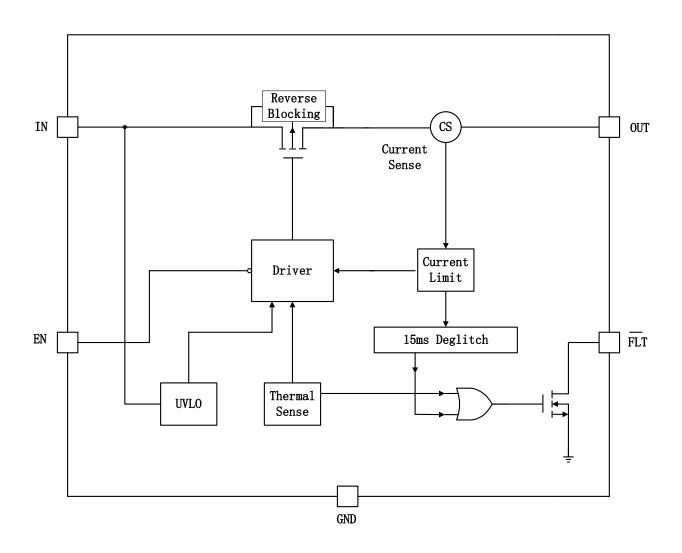




Quiescent Supply Current vs. Ambient Temperature Sv

Switch On-Resistance vs. Ambient Temperature







Operation

WP25141T5-B is an integrated power switch with a low $R_{DS(ON)}$ P-channel MOSFET, internal gate drive circuit. When the WP25141T5-B turns on, it can deliver up to 1.4A continuous current to load. When the device is active, if there is no load, the device only consumes $28\mu A$ supply current, which makes the device suitable for battery powered applications.

Power Supply Considerations

A 0.01 μ F to 0.1 μ F ceramic bypass capacitor between IN and GND, close to the device, is recommended. Placing a high-value electrolytic capacitor on the output pin is recommended when the output load is heavy. This precaution reduces power-supply transients that may cause ringing on the input and minimize the input voltage droops. Additionally, bypassing the output with a 0.01 μ F to 0.1 μ F ceramic capacitor improves the immunity of the device to short-circuit transients.

Power Dissipation and Junction Temperature

The low on-resistance on the P-channel MOSFET allows the small surface-mount packages to pass large currents. It is good design practice to check power dissipation and junction temperature for each application. Begin by determining the RDS(ON) of the P-channel MOSFET relative to the input voltage and operating temperature. Using the highest operating ambient temperature of interest and RDS(ON), the power dissipation per switch can be calculated by:

 $P_D = R_{DS(ON)} \times I^2$

Finally, calculate the junction temperature:

 $T_J = P_D x R_{\theta JA} + T_A$

Where:

T_A= Ambient temperature

 $R_{\theta JA}$ = Thermal resistance

P_D = Total power dissipation

Compare the calculated junction temperature with the maximum junction temperature which is 125°C. If they are

within degrees, either the maximum load current needs to be reduced or another package option will be required.

Over Current

A sense FET is employed to check for over current conditions. When an over current condition is detected, the device maintains a constant output current and reduces the output voltage accordingly. WP25141T5-B will limit the current until the overload condition is removed or the device begins to thermal cycle.

Three possible overload conditions can occur. In the first condition, the output has been shorted before the device is enabled or before V_{IN} has been applied. The WP25141T5-B senses the short and immediately switches into a constant-current output.

In the second condition, a short or an overload occurs while the device is enabled. At the instant the overload occurs, high currents may flow for a short period of time before the current-limit circuit can react. After the current-limit circuit reached the over current trip threshold, the device switches into constant-current mode.

In the third condition, the load has been gradually increased beyond the recommended operating current. The current is permitted to rise until the current-limit threshold is reached or until the thermal limit of the device is exceeded. The WP25141T5-B is capable of delivering current up to the current-limit threshold without damaging the device. Once the threshold has been reached, the device switches into its constant-current mode.

Thermal Protection

Thermal protection prevents damage to the IC when heavy-overload or short-circuit faults are present for extended periods of time. The WP25141T5-B implements a thermal sensing to monitor the operating junction temperature of the power distribution switch. In an over current or short-circuit condition, the junction temperature rises due to excessive power dissipation. Once the die temperature rises to approximately 150° C due to over current conditions, the

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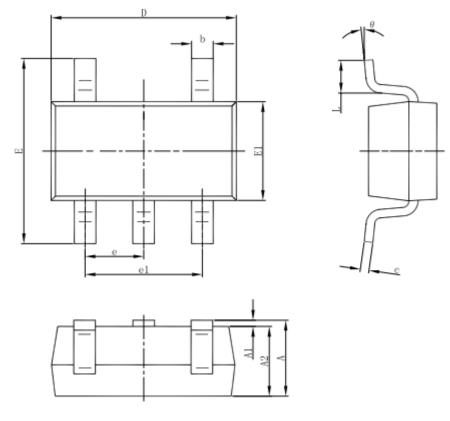
WP25141T5-B



internal thermal sense circuitry turns the power switch off, thus preventing the power switch from damage. Hysteresis is built into the thermal sense circuit, and after the device has cooled approximately 20° C, the switch turns back on. The switch continues to cycle in this manner until the load fault or input power is removed.



Package Information



SOT23-5

0,410.01	DIMENSIONS IN MILLIMETERS			
SYMBOL	MIN	MAX		
Α	1.000	1.350		
A 1	0.000	0.150		
A2	1.000	1.200		
b	0.300	0.500		
С	0.100	0.200		
D	2.820	3.020		
E1	1.500	1.700		
E	2.600	3.000		
е	0.950(BSC)			
e1	1.800	2.000		
L	0.300	0.600		
θ	0° 8°			

WP25141T5-B



Ordering Information

Part Number	Current Limit	Package	Packing Quantity	Marking*
WP25141T5-B	2A	SOT23-5	3k/Reel	WP25141B XXXX

^{*}XXXX is variable.

Contact Information

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Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.

单击下面可查看定价,库存,交付和生命周期等信息

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